



Rambus' Kevin Donnelly Named IP Summit Chair of DesignCon 2011

LOS ALTOS, Calif., Feb 04, 2010 (BUSINESS WIRE) -- Rambus Inc. (NASDAQ: RMBS), one of the world's premier technology licensing companies, today announced that Kevin Donnelly, senior vice president of IP Strategy, will serve as the IP Summit Chair for the DesignCon 2011 conference. The announcement was made during the Keynote Luncheon at DesignCon 2010.

"Rambus is a respected leading vendor of semiconductor IP and a long-time supporter of DesignCon in all aspects of the event," commented Barry Sullivan, content director, International Engineering Consortium. "I'm personally pleased to recognize Kevin's expertise and have his guidance in the development of the IP Summit and DesignCon 2011 event overall."

Mr. Donnelly leads the development of Rambus' IP business strategies. Prior to this position, he served as senior vice president of Engineering, where he led future technology development for Rambus' memory and logic interface products. He holds a bachelor's degree in electrical engineering and computer sciences from the University of California, Berkeley and a master's degree in electrical engineering from San Jose State University. Mr. Donnelly holds numerous patents in high-speed clocking and I/O circuits.

"Throughout DesignCon's 15-year history, the show has evolved into a valuable Silicon Valley venue where engineers and industry leaders converge to discuss, share and showcase the best electronic design technologies from chip, package, board, and system domains," said Kevin Donnelly, senior vice president of IP Strategy at Rambus. "Rambus is proud of its decade-long association with DesignCon, and I look forward to helping move the DesignCon conference forward over the next year."

About Rambus Inc.

Rambus is one of the world's premier technology licensing companies. Founded in 1990, the Company specializes in the invention and design of architectures focused on enhancing the end user experience of computing, communications and consumer electronics applications. Rambus' patented innovations and breakthrough technologies in the area of high-speed memory architectures and complementary technologies have helped industry-leading chip and system companies bring superior products to market. Rambus' technology and renowned integration expertise solve some of the most complex chip and system-level interface challenges. Rambus licenses both its world-class patent portfolio as well as its family of leadership and industry-standard interface products. Headquartered in Los Altos, California, Rambus has regional offices in North Carolina, Ohio, India, Germany, Japan, and Taiwan. Additional information is available at www.rambus.com.

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